# UNISONIC TECHNOLOGIES CO., LTD

3N60K-MT Power MOSFET

## 3.0A, 600V **N-CHANNEL POWER MOSFET**

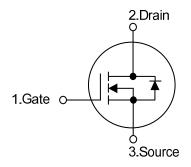
#### **DESCRIPTION**

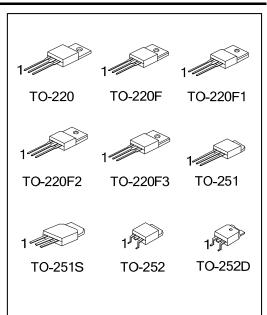
The UTC 3N60K-MT is a high voltage and high current power MOSFET, designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

### **FEATURES**

- \*  $R_{DS(ON)}$  < 3.2 $\Omega$  @  $V_{GS}$  = 10 V,  $I_D$  = 1.5A
- \* Fast switching capability
- \* Avalanche energy specified
- \* Improved dv/dt capability, high ruggedness

#### **SYMBOL**

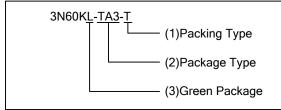




## **ORDERING INFORMATION**

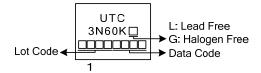
Ordering Number		Doolsogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N60KL-TA3-T	3N60KG-TA3-T	TO-220	G	D	S	Tube	
3N60KL-TF3-T	3N60KG-TF3-T	TO-220F	G	D	S	Tube	
3N60KL-TF1-T	3N60KG-TF1-T	TO-220F1	G	D	S	Tube	
3N60KL-TF2-T	3N60KG-TF2-T	TO-220F2	G	D	S	Tube	
3N60KL-TF3T-T	3N60KG-TF3T-T	TO-220F3	G	D	S	Tube	
3N60KL-TM3-T	3N60KG-TM3-T	TO-251	G	D	S	Tube	
3N60KL-TMS-T	3N60KG-TMS-T	TO-251S	G	D	S	Tube	
3N60KL-TN3-R	3N60KG-TN3-R	TO-252	G	D	S	Tape Reel	
3N60KL-TND-R	3N60KG-TND-R	TO-252D	G	D	S	Tape Reel	

S: Source Pin Assignment: G: Gate D: Drain Note:



- (1) T: Tube, R: Tape Reel
- (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TF3T: TO-220F3, TM3: TO-251, TMS: TO-251S, TN3: TO-252, TND: TO-252D (3) L: Lead Free, G: Halogen Free and Lead Free
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## ■ MARKING



## ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{DSS}$	600	V	
Gate-Source Voltage		$V_{GSS}$	±30	V	
Avalanche Current (Note 2)		$I_{AR}$	3.0	Α	
Continuous Drain Current		$I_{D}$	3.0	Α	
Pulsed Drain Current (Note 2)		$I_{DM}$	12	Α	
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	150	mJ	
Avaianche Energy	Repetitive (Note 2)	$E_{AR}$	7.5	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
	TO-220		75	W	
Power Dissipation	TO-220F/TO-220F1 TO-220F3		34	W	
	TO-220F2	$P_D$	35	W	
	TO-251/TO-251S TO-252/TO-252D		50	W	
	TO-220		1.67	W/°C	
	TO-220F/TO-220F1 TO-220F3	D	0.272	W/°C	
Derate above 25°C	TO-220F2	$P_D$	0.28	W/°C	
	TO-251/TO-251S TO-252/TO-252D		0.4	W/°C	
Junction Temperature		TJ	+150	°C	
Operating Temperature		$T_OPR$	-55 ~ <b>+</b> 150	°C	
Storage Temperature		$T_{STG}$	-55 ~ <b>+</b> 150	ů	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by  $T_{\text{\scriptsize J}}.$
- 3. L=33mH,  $I_{AS}$ =3A,  $V_{DD}$ =50V,  $R_{G}$ =25  $\Omega$ , Starting  $T_{J}$  = 25°C
- 4.  $I_{SD}\leq3.0A$ , di/dt  $\leq200A/\mu s$ ,  $V_{DD}\leq BV_{DSS}$ , Starting  $T_J=25^{\circ}C$

### **■ THERMAL DATA**

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-220F3	$ heta_{ extsf{JA}}$	62.5	°C/W	
	TO-251/TO-251S TO-252/TO-252D		110	°C/W	
Junction to Case	TO-220		1.67	°C/W	
	TO-220F/TO-220F1 TO-220F3	0	3.68	°C/W	
	TO-220F2	$\theta_{JC}$	3.58	°C/W	
	TO-251/TO-251S TO-252/TO-252D		2.5	°C/W	

## ■ **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> =25°C, unless otherwise specified)

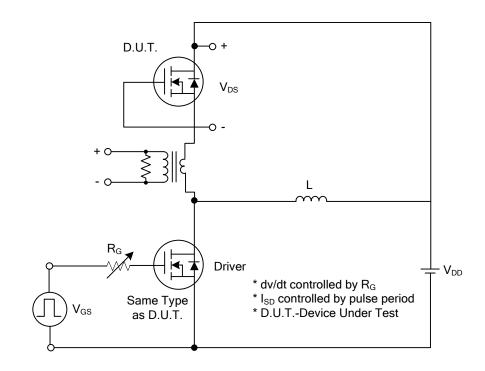
PARAMETER		SYMBOL	TEST CONDITIONS		TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		$BV_{DSS}$	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA				V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V			10	μΑ
Gate-Source Leakage Current	orward	000	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
	Reverse		V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V			-100	nA
Breakdown Voltage Temperature Coefficient		△BV <sub>DSS</sub> /△T <sub>J</sub>	$I_D = 250 \mu A$ ,		0.6		V/°C
			Referenced to 25°C		0.6		V/ C
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	$V_{GS} = 10 \text{ V}, I_D = 1.5 \text{A}$			3.2	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	t Capacitance		V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1MHz		320	610	pF
Output Capacitance		C <sub>ISS</sub>			40	60	pF
Reverse Transfer Capacitance		$C_{RSS}$	71 = 11VIPI2		6	16	pF
<b>SWITCHING CHARACTERISTICS</b>							
Total Gate Charge		$Q_G$	V <sub>DS</sub> = 50V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.3A I <sub>G</sub> = 100 μA (Note 1, 2)		13.5		nC
Gate-Source Charge		$Q_GS$			5.3		nC
Gate-Drain Charge		$Q_GD$	$I_{\text{IG}} = 100  \mu\text{A}  (\text{Note } 1, 2)$		2.7		nC
Turn-On Delay Time		$t_{D(ON)}$			47		ns
Turn-On Rise Time		$t_R$	$V_{DD} = 30V, V_{GS} = 10 V, I_{D} = 0.5 A,$		50		ns
Turn-Off Delay Time		t <sub>D(OFF)</sub>	$R_G = 25\Omega$ (Note 1, 2)		60		ns
Turn-Off Fall Time		t <sub>F</sub>	7		30		ns
SOURCE- DRAIN DIODE RATING	S AND C	HARACTERI	STICS				
Maximum Continuous Drain-Source	Diode					2.0	^
Forward Current		I <sub>S</sub>				3.0	Α
Maximum Pulsed Drain-Source Dio	num Pulsed Drain-Source Diode		·			12	^
Forward Current		I <sub>SM</sub>				12	Α
Drain-Source Diode Forward Voltage		$V_{SD}$	$V_{GS} = 0 \text{ V}, I_{S} = 3.0 \text{ A}$			1.4	V

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%

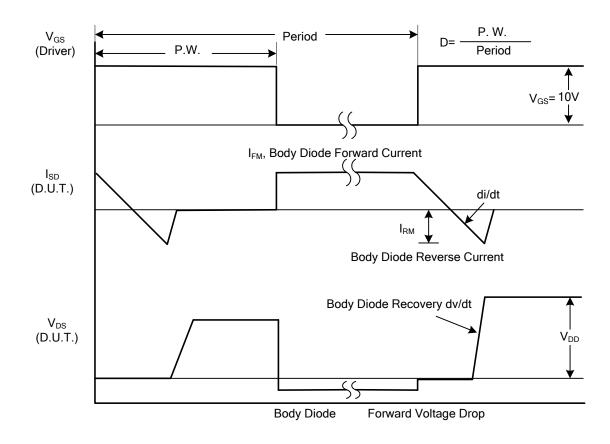
<sup>2.</sup> Essentially independent of operating temperature

3N60K-MT Power MOSFET

### ■ TEST CIRCUITS AND WAVEFORMS



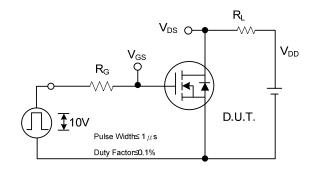
Peak Diode Recovery dv/dt Test Circuit

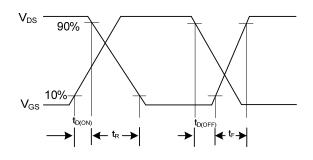


Peak Diode Recovery dv/dt Waveforms

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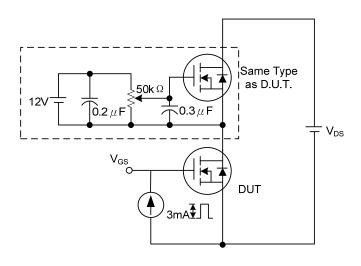
# ■ TEST CIRCUITS AND WAVEFORMS (Cont.)

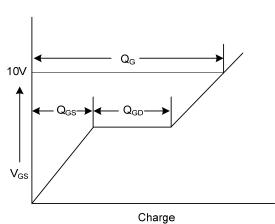




**Switching Test Circuit** 

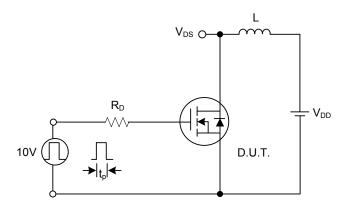
**Switching Waveforms** 

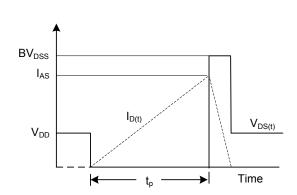




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 

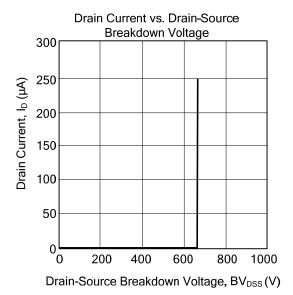


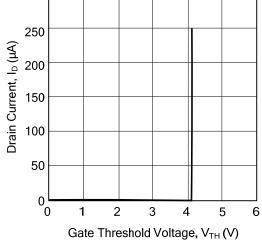


**Unclamped Inductive Switching Test Circuit** 

**Unclamped Inductive Switching Waveforms** 

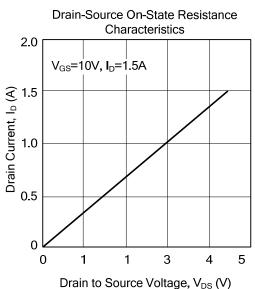
### **■ TYPICAL CHARACTERISTICS**

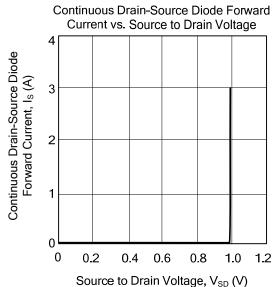




Drain Current vs. Gate Threshold Voltage

300





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